

LM45B/LM45C

SOT-23 Precision Centigrade Temperature Sensors

General Description

The LM45 series are precision integrated-circuit temperature sensors, whose output voltage is linearly proportional to the Celsius (Centigrade) temperature. The LM45 does not require any external calibration or trimming to provide accuracies of $\pm 2^\circ\text{C}$ at room temperature and $\pm 3^\circ\text{C}$ over a full -20 to $+100^\circ\text{C}$ temperature range. Low cost is assured by trimming and calibration at the wafer level. The LM45's low output impedance, linear output, and precise inherent calibration make interfacing to readout or control circuitry especially easy. It can be used with a single power supply, or with plus and minus supplies. As it draws only $120\ \mu\text{A}$ from its supply, it has very low self-heating, less than 0.2°C in still air. The LM45 is rated to operate over a -20° to $+100^\circ\text{C}$ temperature range.

Applications

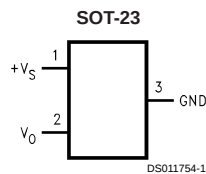
- Battery Management
- FAX Machines
- Printers

- Portable Medical Instruments
- HVAC
- Power Supply Modules
- Disk Drives
- Computers
- Automotive

Features

- Calibrated directly in $^\circ\text{Celsius}$ (Centigrade)
- Linear $+10.0\ \text{mV}/^\circ\text{C}$ scale factor
- $\pm 3^\circ\text{C}$ accuracy guaranteed
- Rated for full -20° to $+100^\circ\text{C}$ range
- Suitable for remote applications
- Low cost due to wafer-level trimming
- Operates from 4.0V to 10V
- Less than $120\ \mu\text{A}$ current drain
- Low self-heating, 0.20°C in still air
- Nonlinearity only $\pm 0.8^\circ\text{C}$ max over temp
- Low impedance output, $20\ \Omega$ for $1\ \text{mA}$ load

Connection Diagram



Top View
See NS Package Number MA03B

Order Number	SOT-23 Device Marking	Supplied As
LM45BIM3	T4B	1000 Units on Tape and Reel
LM45BIM3X	T4B	3000 Units on Tape and Reel
LM45CIM3	T4C	1000 Units on Tape and Reel
LM45CIM3X	T4C	3000 Units on Tape and Reel

Typical Applications

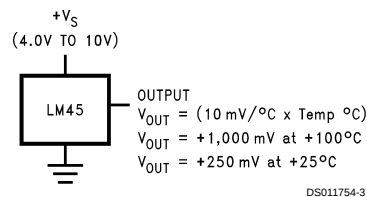
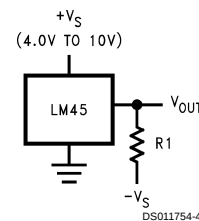


FIGURE 1. Basic Centigrade Temperature Sensor ($+2.5^\circ\text{C}$ to $+100^\circ\text{C}$)



Choose $R_1 = -V_S/50\ \mu\text{A}$
 $V_{OUT} = (10\ \text{mV}/^\circ\text{C} \times \text{Temp } ^\circ\text{C})$
 $V_{OUT} = +1,000\ \text{mV at } +100^\circ\text{C}$
 $= +250\ \text{mV at } +25^\circ\text{C}$
 $= -200\ \text{mV at } -20^\circ\text{C}$

FIGURE 2. Full-Range Centigrade Temperature Sensor (-20°C to $+100^\circ\text{C}$)

Absolute Maximum Ratings (Note 1)

Supply Voltage	+12V to -0.2V
Output Voltage	+V _S + 0.6V to -1.0V
Output Current	10 mA
Storage Temperature	-65°C to +150°C
Lead Temperature:	
SOT Package (Note 2):	
Vapor Phase (60 seconds)	215°C
Infrared (15 seconds)	220°C
ESD Susceptibility (Note 3):	
Human Body Model	2000V
Machine Model	250V

Operating Ratings (Note 1)

Specified Temperature Range	
(Note 4)	T _{MIN} to T _{MAX}
LM45B, LM45C	-20°C to +100°C
Operating Temperature Range	
LM45B, LM45C	-40°C to +125°C
Supply Voltage Range (+V _S)	+4.0V to +10V

Electrical Characteristics

Unless otherwise noted, these specifications apply for +V_S = +5Vdc and I_{LOAD} = +50 µA, in the circuit of *Figure 2*. These specifications also apply from +2.5°C to T_{MAX} in the circuit of *Figure 1* for +V_S = +5Vdc. **Boldface limits apply for T_A = T_J = T_{MIN} to T_{MAX}**; all other limits T_A = T_J = +25°C, unless otherwise noted.

Parameter	Conditions	LM45B		LM45C		Units (Limit)
		Typical	Limit (Note 5)	Typical	Limit (Note 5)	
Accuracy (Note 6)	T _A = +25°C		±2.0		±3.0	°C (max)
	T _A = T _{MAX}		±3.0		±4.0	°C (max)
	T _A = T _{MIN}		±3.0		±4.0	°C (max)
Nonlinearity (Note 7)	T _{MIN} ≤ T _A ≤ T _{MAX}		±0.8		±0.8	°C (max)
Sensor Gain (Average Slope)	T _{MIN} ≤ T _A ≤ T _{MAX}		+9.7		+9.7	mV/°C (min)
			+10.3		+10.3	mV/°C (max)
Load Regulation (Note 8)	0 ≤ I _L ≤ +1 mA		±35		±35	mV/mA (max)
Line Regulation (Note 8)	+4.0V ≤ +V _S ≤ +10V		±0.80		±0.80	mV/V (max)
			±1.2		±1.2	mV/V (max)
Quiescent Current (Note 9)	+4.0V ≤ +V _S ≤ +10V, +25°C		120		120	µA (max)
	+4.0V ≤ +V _S ≤ +10V		160		160	µA (max)
Change of Quiescent Current (Note 9)	4.0V ≤ +V _S ≤ 10V		2.0		2.0	µA (max)
Temperature Coefficient of Quiescent Current		+2.0		+2.0		µA/°C
Minimum Temperature for Rated Accuracy	In circuit of <i>Figure 1</i> , I _L = 0		+2.5		+2.5	°C (min)
Long Term Stability (Note 10)	T _J = T _{MAX} , for 1000 hours	±0.12		±0.12		°C

Note 1: Absolute Maximum Ratings indicate limits beyond which damage to the device may occur. DC and AC electrical specifications do not apply when operating the device beyond its rated operating conditions.

Note 2: See AN-450 "Surface Mounting Methods and Their Effect on Product Reliability" or the section titled "Surface Mount" found in a current National Semiconductor Linear Data Book for other methods of soldering surface mount devices.

Note 3: Human body model, 100 pF discharged through a 1.5 kΩ resistor. Machine model, 200 pF discharged directly into each pin.

Note 4: Thermal resistance of the SOT-23 package is 260°C/W, junction to ambient when attached to a printed circuit board with 2 oz. foil as shown in *Figure 3*.

Note 5: Limits are guaranteed to National's AOQL (Average Outgoing Quality Level).

Note 6: Accuracy is defined as the error between the output voltage and 10 mV/°C times the device's case temperature, at specified conditions of voltage, current, and temperature (expressed in °C).

Note 7: Nonlinearity is defined as the deviation of the output-voltage-versus-temperature curve from the best-fit straight line, over the device's rated temperature range.

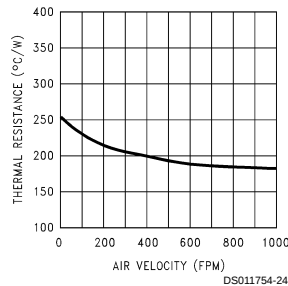
Note 8: Regulation is measured at constant junction temperature, using pulse testing with a low duty cycle. Changes in output due to heating effects can be computed by multiplying the internal dissipation by the thermal resistance.

Note 9: Quiescent current is measured using the circuit of *Figure 1*.

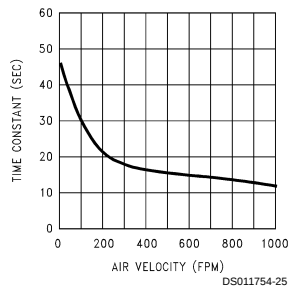
Note 10: For best long-term stability, any precision circuit will give best results if the unit is aged at a warm temperature, and/or temperature cycled for at least 46 hours before long-term life test begins. This is especially true when a small (Surface-Mount) part is wave-soldered; allow time for stress relaxation to occur.

Typical Performance Characteristics To generate these curves the LM45 was mounted to a printed circuit board as shown in *Figure 3*.

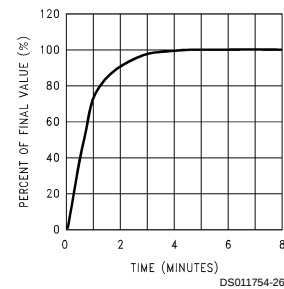
**Thermal Resistance
Junction to Air**



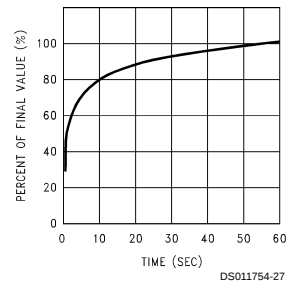
Thermal Time Constant



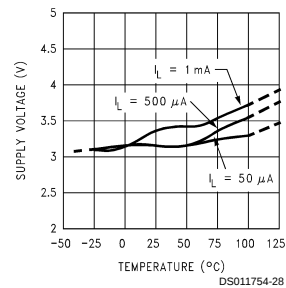
**Thermal Response in Still Air
with Heat Sink (*Figure 3*)**



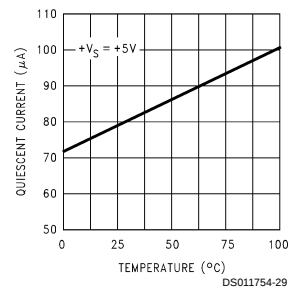
**Thermal Response
in Stirred Oil Bath
with Heat Sink**



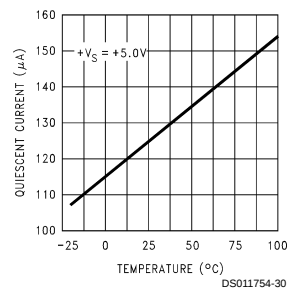
**Start-Up Voltage
vs Temperature**



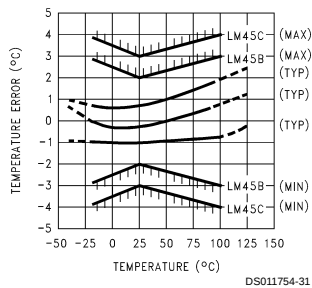
**Quiescent Current
vs Temperature
(In Circuit of *Figure 1*)**



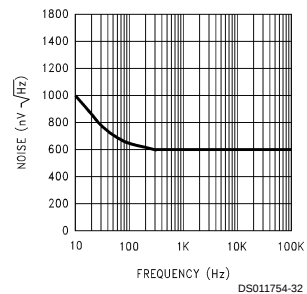
**Quiescent Current
vs Temperature
(In Circuit of *Figure 2*)**



**Accuracy vs Temperature
(Guaranteed)**

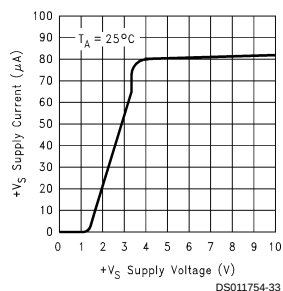


Noise Voltage



Typical Performance Characteristics To generate these curves the LM45 was mounted to a printed circuit board as shown in Figure 3. (Continued)

Supply Voltage vs Supply Current



Start-Up Response

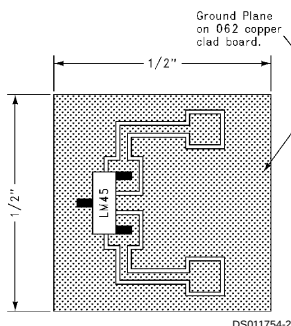
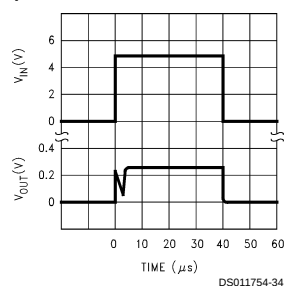


FIGURE 3. Printed Circuit Board Used for Heat Sink to Generate All Curves.
1/2" Square Printed Circuit Board with 2 oz. Foil or Similar

Applications

The LM45 can be applied easily in the same way as other integrated-circuit temperature sensors. It can be glued or cemented to a surface and its temperature will be within about 0.2°C of the surface temperature.

This presumes that the ambient air temperature is almost the same as the surface temperature; if the air temperature were much higher or lower than the surface temperature, the actual temperature of the LM45 die would be at an intermediate temperature between the surface temperature and the air temperature.

To ensure good thermal conductivity the backside of the LM45 die is directly attached to the GND pin. The lands and traces to the LM45 will, of course, be part of the printed circuit board, which is the object whose temperature is being measured. These printed circuit board lands and traces will not cause the LM45s temperature to deviate from the desired temperature.

Alternatively, the LM45 can be mounted inside a sealed-end metal tube, and can then be dipped into a bath or screwed into a threaded hole in a tank. As with any IC, the LM45 and accompanying wiring and circuits must be kept insulated and dry, to avoid leakage and corrosion. This is especially true if the circuit may operate at cold temperatures where condensation can occur. Printed-circuit coatings and varnishes such

as Humiseal and epoxy paints or dips are often used to insure that moisture cannot corrode the LM45 or its connections.

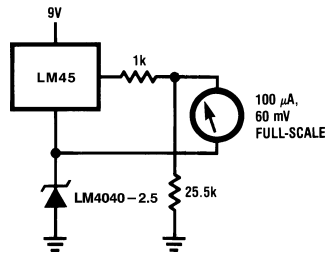
Temperature Rise of LM45 Due to Self-Heating (Thermal Resistance)

	SOT-23 no heat sink*	SOT-23 small heat fin**
Still air	450°C/W	260°C/W
Moving air		180°C/W

* Part soldered to 30 gauge wire.

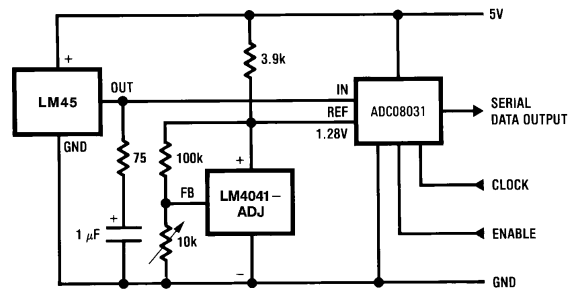
** Heat sink used is 1/2" square printed circuit board with 2 oz. foil with part attached as shown in Figure 3.

Typical Applications (Continued)



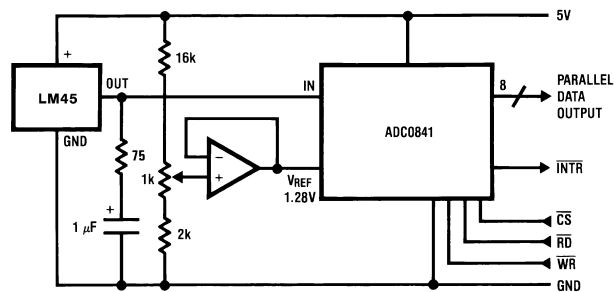
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FIGURE 10. Expanded Scale Thermometer
(50° to 80° Fahrenheit, for Example Shown)



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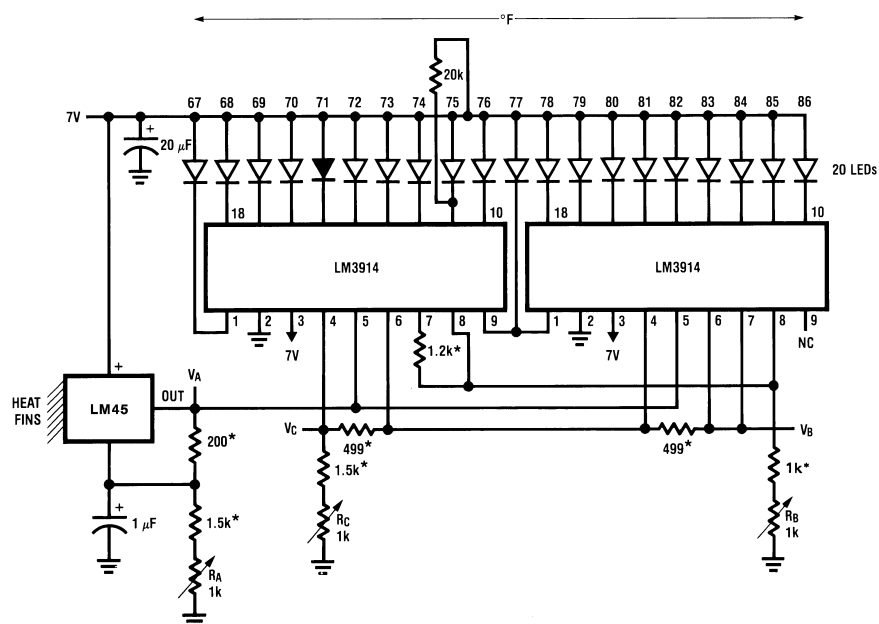
FIGURE 11. Temperature To Digital Converter (Serial Output) (+128°C Full Scale)



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FIGURE 12. Temperature To Digital Converter (Parallel TRI-STATE® Outputs for
Standard Data Bus to μ P Interface) (128°C Full Scale)

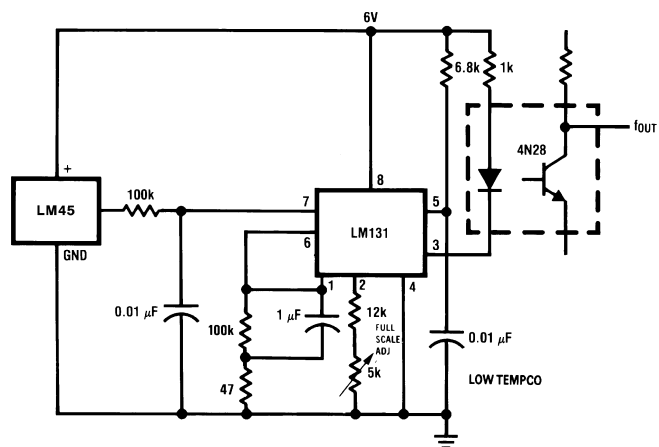
Typical Applications (Continued)



DS011754-20

- * =1% or 2% film resistor
- Trim R_B for $V_B=3.075V$
- Trim R_C for $V_C=1.955V$
- Trim R_A for $V_A=0.075V + 100mV/^\circ C \times T_{ambient}$
- Example, $V_A=2.275V$ at $22^\circ C$

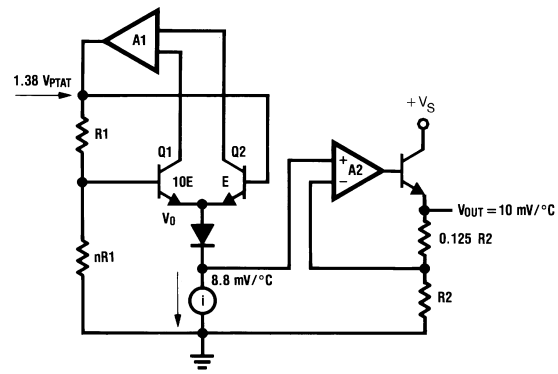
FIGURE 13. Bar-Graph Temperature Display (Dot Mode)



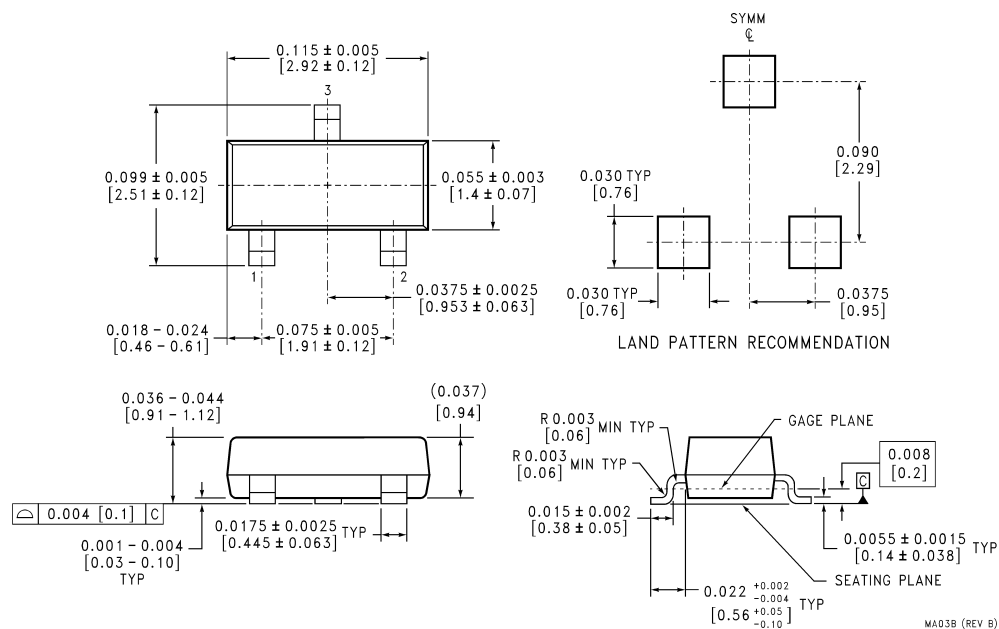
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**FIGURE 14. LM45 With Voltage-To-Frequency Converter And Isolated Output
(2.5°C to +100°C; 25 Hz to 1000 Hz)**

Block Diagram



DS011754-22

Physical Dimensions inches (millimeters) unless otherwise noted

SOT-23 Molded Small Outline Transistor Package (M3)
Order Number LM45BIM3, LM45BIM3X, LM45CIM3 or LM45CIM3X
NS Package Number MA03B

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